### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Randall R. Baraso	08/10/2011
Kazutoshi Tsuchida	08/10/2011
Hiroaki Wakabayashi	08/10/2011

# RECEIVING PARTY DATA

Name:	Hitachi Aloka Medical, Ltd.
Street Address:	10 Fairfield Boulevard
City:	Wallingford
State/Country:	CONNECTICUT
Postal Code:	06492

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12917721

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	117140.00007
NAME OF SUBMITTER:	Basam F Nabulsi

**Total Attachments: 2** 

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> **PATENT** REEL: 026829 FRAME: 0707

ATTORNEY DOCKET NO.: 117140.00007

# **ASSIGNMENT**

For good and valuable consideration, the receipt of which is hereby acknowledged, I the undersigned,

Randall R. Baraso, 3465 Shagbark Circle, Mount Pleasant, SC 29466
Kazutoshi Tsuchida, 2-9-24 Shinmachi, Oume, Tokyo, 198-0024 Japan
Hiroaki Wakabayashi, 2-12-5-203 Kyounan, Musashino, Tokyo, 180-0023 Japan
(insert full name(s) and post office addresses of inventors)

(hereinafter, "Assignor"), who has created a certain invention for which an application for United States Letters Patent entitled:

# ULTRASOUND SYSTEMS AND METHODS FOR ORTHOPEDIC APPLICATIONS

(insert title of invention)

(check one)

for which the application is attached hereto; or

for which the application for U.S. Letters Patent has been filed on November 2, 2010 as Application Serial No. 12/917,721

Do hereby sell, assign and transfer to:

HITACHI ALOKA MEDICAL, LTD., 10 Fairfield Blvd., Wallingford, CT 06492 (insert full name(s) and post office addresses of assignee)

(hereinafter, "Assignee"), its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

I authorize Assignee to apply for and receive Letters Patent for such protection in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, but without charge to Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, and extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF, I have hereunto set my signature below.

Signature of inventor:	
Date: 10 lug 2011	Kardlel RAG
,	Randall R. Baraso
Signature of inventor:	
Date: 10. AUG., 2011	Hazutoshi Tsuchida
	Kazutoshi Tsuchida
Signature of inventor:	-
Date: 10. AVG. 2611	shiroski Wakabayashi
	Hiroaki Wakabayashi